

# **Description**

The SPEN-210A is a 100 V, 10 A, Schottky diode that has the improved characteristics of V<sub>F</sub> and I<sub>R</sub>. These characteristics realize the improvement of power supply efficiency and the high frequency system.

#### **Features**

| • V <sub>RM</sub>             | 100 V      |
|-------------------------------|------------|
| • I <sub>F(AV)</sub>          | 10 A       |
| • $V_F (I_F = 5.0 \text{ A})$ | 0.85 V typ |
| - D. HC C 1'                  |            |

RoHS Compliant

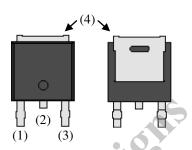
# **Application**

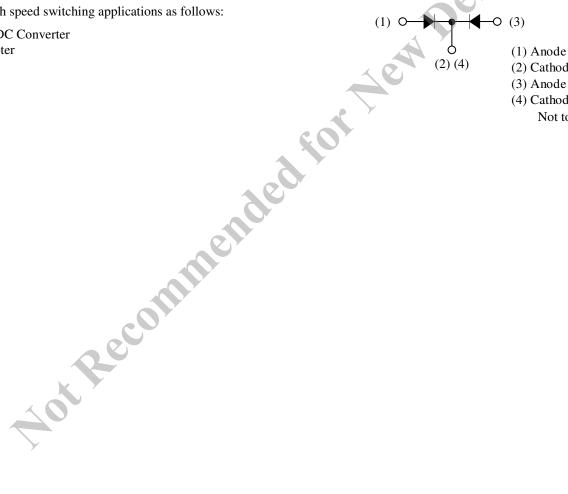
The high speed switching applications as follows:

- DC-DC Converter
- Adapter

### **Package**

TO252





(2)(4)

- (2) Cathode
- (3) Anode (4) Cathode

Not to scale

## SPEN-210A

# **Absolute Maximum Ratings**

Unless otherwise specified,  $T_A = 25$  °C

| Parameter                                      | Symbol           | Rating     | Unit   | Remarks  |
|--|------------------|------------|--------|--|
| Peak Repetitive Reverse Voltage <sup>(1)</sup> | V <sub>RSM</sub> | 100        | V      |  |
| Repetitive Reverse Voltage <sup>(1)</sup>      | $V_{RM}$         | 100        | V      |  |
| Average Forward Current                        | $I_{F(AV)}$      | 10         | A      | See Figure 1 and Figure 2                                  |
| Surge Forward Current <sup>(1)</sup>           | $I_{FSM}$        | 100        | A      | Half cycle sine wave,<br>positive side,<br>10 ms, one shot |
| I <sup>2</sup> t Limiting Value <sup>(1)</sup> | I <sup>2</sup> t | 50         | $A^2s$ | $1 \text{ ms} \le t \le 10 \text{ ms}$                     |
| Junction Temperature                           | $T_{J}$          | -40 to 150 | °C     |  |
| Storage Temperature                            | $T_{ m STG}$     | -40 to 150 | °C     | 20   |

### **Electrical Characteristics**

Unless otherwise specified,  $T_A = 25$  °C

| Parameter  | Symbol               | Conditions                          | Min.    | Typ. | Max. | Unit | Remarks |
|--|----------------------|-------------------------------------|---------|------|------|------|---------|
| Forward Voltage Drop <sup>(1)</sup>                              | $V_{F}$              | $I_F = 5.0 \text{ A}$               | <b></b> | >_   | 0.85 | V    |         |
| Reverse Leakage Current <sup>(1)</sup>                           | $I_R$                | $V_R = V_{RM}$                      | 0       | _    | 100  | μA   |         |
| Reverse Leakage Current<br>Under High Temperature <sup>(1)</sup> | $H \cdot I_R$        | $V_R = V_{RM}, T_J = 150 ^{\circ}C$ |         |      | 50   | mA   |         |
| Thermal Resistance   | $R_{\text{th(J-C)}}$ | Between junction and case           | _       |      | 5.0  | °C/W |         |
| Agi Recollination  |                      |                                     |         |      |      |      |         |

<sup>(1)</sup> The rating of one chip.

# **Rating and Characteristics Curves**

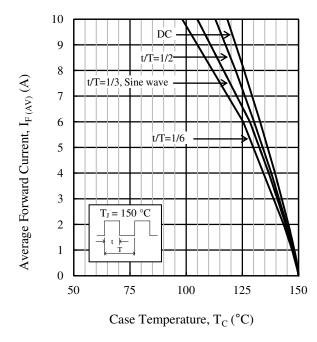


Figure 1.  $I_{F(AV)}$  vs. Case Temperature Curves  $V_R$  = 0 V

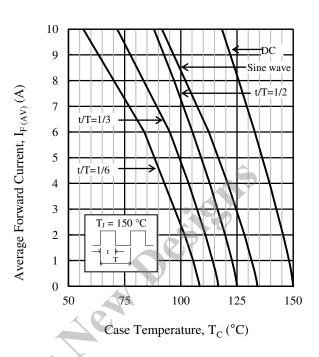


Figure 2.  $I_{F(AV)}$  vs. Case Temperature Curves  $V_R = 100 \ V$ 

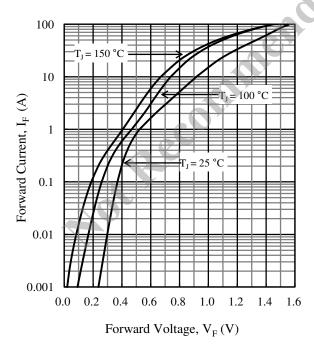


Figure 3.  $I_F - V_F$  Typical Characteristics

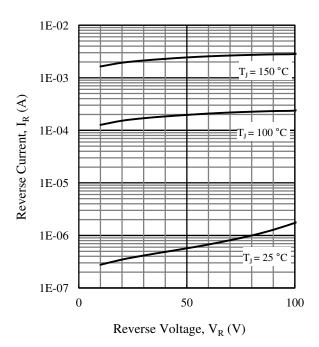
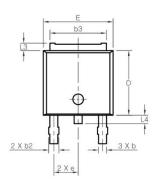
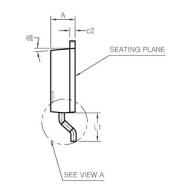


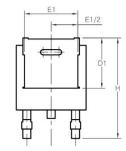
Figure 4.  $I_R - V_R$  Typical Characteristics

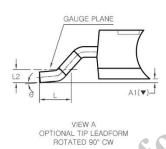
## **Physical Dimensions**

#### • TO252









2.20 2.30 2.40 A1 (▼) 0.00 0.127 0.66 0.76 0.86 b 0.96 b2 5.04 5,34 b3 5.64 0.50 c2 0.40 0.60 D 5.90 6.10 6.30 D1 (4.75) 6.40 6.60 6.80 E1 (5.04) 2.30 BSC е 9.20 9.50 9.80 1.27 1.47 1.67 И 2.50 2.70 2.90 0.508 BSC 0.50 0.90 L3 0.70 L4 0.60 0.80 1.00 10° Θ 0° θ1 (5°)

MOM

MAX

SYMBOL

MIN

#### **NOTES:**

- Dimensions in millimeters
- These dimensions do not include protrusions of the mold.
- The "()" mark is the reference.
- Coplanarity: MAX. 0.10 mm
- The "L4" symbol is a protrusion of the lead frame.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, be sure to minimize the working time, within the following limits:

Flow:  $260 \pm 5$  °C /  $10 \pm 1$  s, 2 times

Soldering Iron:  $380 \pm 5$  °C /  $3.5 \pm 0.5$  s, 1 time

# **Marking Diagram**

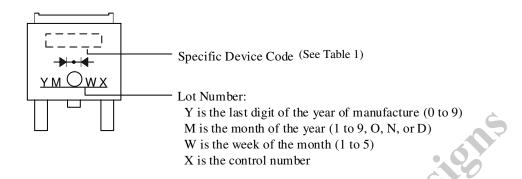


Table 1 Specific Device Code

|    | Specific Device Code | Part Number |
|----|----------------------|-------------|
|    | EN210A               | SPEN-210A   |
|    |                      |             |
|    |                      | 60,         |
|    |                      |             |
|    | 96                   |             |
|    |                      |             |
|    |                      |             |
|    | ommende              |             |
|    |                      |             |
| 26 |                      |             |
|    |                      |             |
| 40 |                      |             |
| >  |                      |             |
|    |                      |             |

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